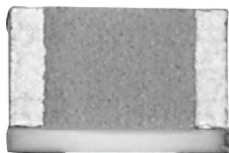
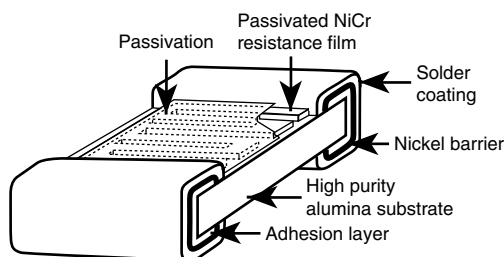


# CECC (E) 40401-010 Qualified Thin Film Chip Resistors



Utilizing proven expertise in Thin Film resistors, VISHAY provides a CECC qualified chip with the same reliability and stability found in QPL resistors. These chips are available in a wide range of sizes, values and performance characteristics.

## CONSTRUCTION



## FEATURES

- Nickel barrier for high temperature operating conditions
- Tight TCR < 10 ppm/°C, and in lot tracking < 5 ppm/°C in (-55 °C, +155 °C temperature range)
- Very low noise < 35 dB and voltage coefficient 0.1 ppm/V
- Non-inductive
- Laser trimmed down to 0.1 %
- Wraparound resistance less than 0.01 Ω
- Antistatic waffle-pack or tape and reel packaging available
- High stability (0.05 % - 1000 h at Pn at +70 °C)
- Withstand moisture resistance test of AEC-Q200
- Conform to EN 140401 804
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



RoHS\*  
Available

### Note

\* This datasheet provides information about parts that are RoHS-compliant and/or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information/tables in this datasheet for details.

## STANDARD ELECTRICAL SPECIFICATIONS

MODEL	SIZE	RESISTANCE RANGE <sup>(1) (2)</sup> Ω	RATED POWER Pn W	LIMITING ELEMENT VOLTAGE (UL) V	TOLERANCE ± %	TEMPERATURE COEFFICIENT ± ppm/°C
RV E	0505	100 to 260K	0.125	50	0.1, 0.5, 1, 2, 5	10, 25
RV E	0603	100 to 260K	0.125	50	0.1, 0.5, 1, 2, 5	10, 25
RV E	0805	100 to 300K	0.200	50	0.1, 0.5, 1, 2, 5	10, 25
RV E	1206	100 to 1M	0.330	75	0.1, 0.5, 1, 2, 5	10, 25

### Notes

<sup>(1)</sup> Extended resistance range on request

<sup>(2)</sup> For ohmic range versus tolerance and TCR, see detailed table

## CLIMATIC SPECIFICATIONS

Operating temperature range	-55 °C to +155 °C
Storage temperature range	-55 °C to +155 °C

## MECHANICAL SPECIFICATIONS

Resistive material	Nichrome
Substrate material	Alumina
Plating	Tin lead over nickel or tin silver over nickel or gold over nickel
Marking resistance to solvents	Per CECC Specs

## OHMIC RANGE VS. TOLERANCE AND TCR

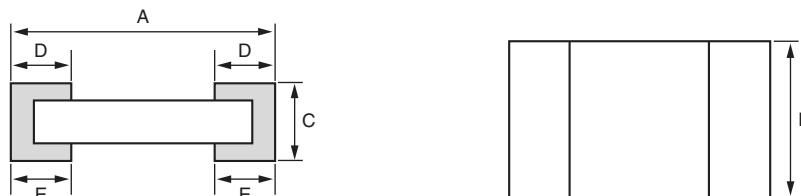
CASE SIZE	OHMIC RANGE Ω	TOLERANCE %	TCR ppm/°C
0505	100 < 500	0.5; 1; 2; 5	10, 25
0505	500 to 260K	0.1; 0.5; 1; 2; 5	10, 25
0603	100 < 500	0.5; 1; 2; 5	10, 25
0603	500 to 260K	0.1; 0.5; 1; 2; 5	10, 25
0805	100 < 500	0.5; 1; 2; 5	10, 25
0805	500 to 300K	0.1; 0.5; 1; 2; 5	10, 25
1206	100 < 500	0.5; 1; 2; 5	10, 25
1206	500 to 1M	0.1; 0.5; 1; 2; 5	10, 25

## TECHNICAL SPECIFICATIONS

TEST	SPECIFICATIONS	CONDITIONS
Absolute TCR	E: ± 25 ppm/°C Y: ± 10 ppm/°C	-55 °C to +155 °C
Absolute tolerance	± 0.1 %, ± 0.5 %, ± 1 %, ± 2 %, ± 5 % (R ≥ 500 Ω) ± 0.5 %, ± 1 %, ± 2 %, ± 5 % (R ≥ 100 Ω)	
Voltage coefficient	0.1 ppm/V	
Noise	-35 dB typical	
Thermal EMF	< 0.1 μV/°C	
Load life stability	± (0.1 % Rn <sup>(3)</sup> ± 0.05 Ω)	1000 h Pn at +70 °C

### Note

<sup>(3)</sup> Rn: Nominal resistance

**DIMENSIONS** in millimeters (inches)


SERIES/ CASE SIZES	A		B		D/E		C	
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.
RV 0505	1.198 (0.047)	1.502 (0.059)	1.143 (0.045)	1.397 (0.055)	0.250 (0.010)	0.510 (0.020)	0.373 (0.015)	0.627 (0.025)
RV 0603	1.368 (0.054)	1.672 (0.066)	0.623 (0.025)	0.877 (0.035)	0.250 (0.010)	0.510 (0.020)	0.373 (0.015)	0.627 (0.025)
RV 0805	1.758 (0.069)	2.062 (0.081)	1.143 (0.045)	1.397 (0.055)	0.250 (0.010)	0.510 (0.020)	0.373 (0.015)	0.627 (0.025)
RV 1206	2.908 (0.114)	3.212 (0.126)	1.473 (0.058)	1.727 (0.068)	0.250 (0.010)	0.510 (0.020)	0.373 (0.015)	0.627 (0.025)

**POPULAR OPTION**

AEC-Q200 moisture resistance

Option to order: 0058: Specific production process to withstand 85 °C/85 % RH at Pn/10

**ENVIRONMENTAL TEST**

TEST	CONDITIONS	VALUES AND DRIFTS ( $\Delta R/R \pm \%$ )	
		CECC REQUIREMENTS	TYPICAL PERFORMANCE
Overload	6.25 x rated power / 2 s (or 2 UL)	0.05 % Rn <sup>(2)</sup> + 0.05 $\Omega$	0.01 % Rn <sup>(2)</sup>
Climatic sequences <sup>(1)</sup>	-55 °C / +155 °C 5 moisture cycles	0.1 % Rn <sup>(2)</sup> + 0.05 $\Omega$	0.02 % Rn <sup>(2)</sup>
Thermal shock <sup>(1)</sup>	-55 °C / +155 °C 5 cycles 30 min	0.05 % Rn <sup>(2)</sup> + 0.05 $\Omega$	0.02 % Rn <sup>(2)</sup>
Load life <sup>(1)</sup>	+70 °C/Pn 1000 h	0.1 % Rn <sup>(2)</sup> + 0.05 $\Omega$	0.05 % Rn <sup>(2)</sup>
Resistance to solder heat	+260 °C/ 10 s	0.05 % Rn <sup>(2)</sup> + 0.05 $\Omega$	0.02 % Rn <sup>(2)</sup>
Moisture resistance <sup>(1)</sup>	+40 °C / 93 % HR Pn / 10	0.1 % Rn <sup>(2)</sup> + 0.05 $\Omega$	0.01 % Rn <sup>(2)</sup>
	AEC-Q200 <sup>(3)</sup> 85 °C / 85 % RH / Pn / 10 1000 h	0.5 % + 0.05 $\Omega$	Max. < 0.3 % + 0.05 $\Omega$
High temperature storage	1000 h at + 155 °C	0.1 % Rn <sup>(2)</sup> + 0.05 $\Omega$	0.05 % Rn <sup>(2)</sup>
Bending <sup>(1)</sup>	10 bends / 2 mm / 5 s	0.05 % Rn <sup>(2)</sup> + 0.05 $\Omega$	0.02 % Rn <sup>(2)</sup>

**SPECIFIC CONDITIONS DUE TO TERMINATION TYPE**

TEST	CONDITIONS		VALUES AND DRIFTS	
	B; G	N	VISHAY REQUIREMENTS	TYPICAL PERFORMANCE
Solderability	+235 °C/2 s Sn60Pb40 alloy	+245 °C/3 s Sn97Ag3 alloy	VISUAL INSPECTION	
High T° reflow profile	N/A	+255 °C/40 s (on parts)	0.02 % Rn <sup>(2)</sup> + 0.05 $\Omega$	0.01 % Rn <sup>(2)</sup> + 0.05 $\Omega$

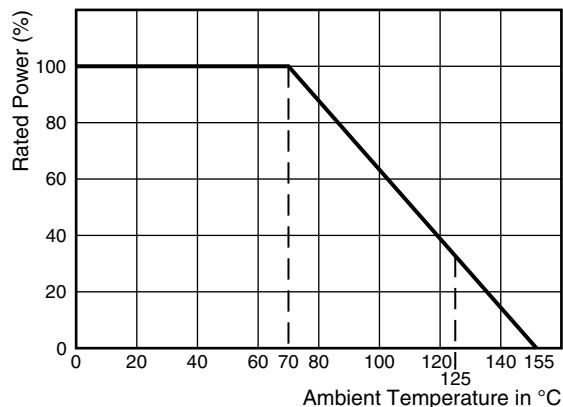
**Notes**
<sup>(1)</sup> Test requiring parts to be mounted on PCB will be performed with the requirement that termination alloy will be the same as solder paste alloy. Gold termination will be tested as B termination

<sup>(2)</sup> Rn: Nominal Resistance  
Pn: Nominal Power

<sup>(3)</sup> Option to order: 0058

**PACKAGING INFORMATION**

SIZE	NUMBER OF PIECES PER PACKAGE		TAPE WIDTH	
	WAFFLE PACK (2" x 2")	TAPE AND REEL Min.      Max.		
0505	100	100	4000	8 mm (0.315")
0603			5000	
0805	100		4000	
1206	140			

**DERATING CURVE****GLOBAL PART NUMBER INFORMATION**

New Global Part Numbering: RV0505E1001DBT0099

R	V	0	5	0	5	E	1	0	0	1	D	B	T	0	0	9	9
GLOBAL MODEL	SIZE	TCR	VALUE	TOLERANCE	TERMINATION	PACKAGING	OPTION										
	0505 0603 0805 1206	E = ± 25 ppm/°C Y = ± 10 ppm/°C	The first 3 digits (2 digits are enough for tolerance G and J) are significant figures and the last digit specifies the number of zeros to follow. R designates decimal point  10R0 = 10 Ω 3901 = 3900 Ω 1004 = 1 MΩ	B = ± 0.1 % D = ± 0.5 % F = ± 1 % G = ± 2 % J = ± 5 %	B: SnPb over nickel barrier N: SnAg over nickel barrier G: Gold over nickel barrier	For more information see "Codification of packaging" table	Leave blank if no option										

B: Lead bearing version  
N and G: Lead (Pb)-free / RoHS version

Historical Part Number example: RV 0505 25PPM 1K 0.5 % B TR R1016

**PART NUMBER DESCRIPTION** (for information only)

RV	0505	25 PPM	1K	0.5 %	B	TR	R1016
MODEL	SIZE	TCR	OHMIC VALUE	TOLERANCE	TERMINATION	PACKAGING	OPTION



<b>CODIFICATION OF PACKAGING</b>	
<b>CODE 18</b>	<b>PACKAGING</b>
<b>WAFFLE PACK</b>	
W	100 min., 1 mult
WA	100 min., 100 mult (available only in size 1206)
<b>PLASTIC TAPE (Standard for all sizes.)</b>	
T	100 min., 1 mult
TA	100 min., 100 mult
TB	250 min., 250 mult
TC	500 min., 500 mult
TD	1000 min., 1000 mult
TE	2500min., 2500 mult
TF	Full tape (quantity depending on size of chips)
<b>PAPER TAPE (Available for 0603, 0805, and 1206. Please consult Vishay Sfernice for other sizes.)</b>	
PT	100 min., 1 mult
PA	100 min., 100 mult
PB	250 min., 250 mult
PC	500 min., 500 mult
PD	1000 min., 1000 mult
PE	2500min., 2500 mult
PF	Full tape (quantity depending on size of chips)



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